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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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Features

- 5.6mm x 3.0mm x 0.77mm SMD LED
- IR-reflow compatible
- Standard Package: 2,000pcs / Reel
- White SMD package with silicone resin
- MSL (Moisture Sensitivity Level): 2a
- RoHS compliant







ATTENTION

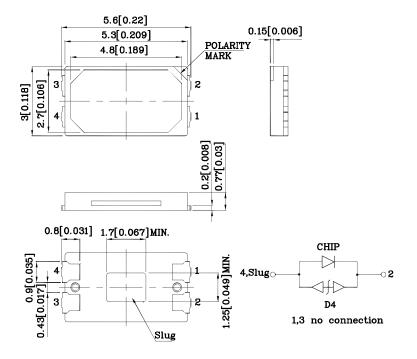
5.6mm x 3.0mm SURFACE MOUNT LED LAMP

OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Typical Applications

- Entertainment and accent lighting
- Architectural lighting
- Ideal substitute for halogen and florescent lighting
- Automotive interior and exterior lighting
- Specialty lighting (Markers, Beacon, Pathway)

Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

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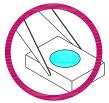


Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

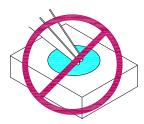
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

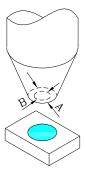




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

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Part Number: XZMOLA143S



5.6mm x 3.0mm SURFACE MOUNT LED LAMP

Part Number	Emitting Color	Emitting Material	Lens-color	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	Viewing Angle 2 θ 1/2			
				Min.	Тур.	Min.	Тур.	
XZMOLA143S	Red	AlGaInP	Water Clear	3600*	4190*	12*	13.7*	120°

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity / luminous flux: +/-15%.
- 3. LEDs are binned according to their luminous flux.

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	PD	450	mW
Junction Temperature [1]	$\mathrm{T}\mathrm{J}$	110	°C
Operating Temperature	Top	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	°C
DC Forward Current [1]	IF	150	mA
Reverse Voltage	$V_{\rm R}$	5	V
Peak Forward Current [2]	IFM	270	mA
Thermal Resistance [1] (Junction/ambient)	Rth j-a	130	°C/W
Thermal Resistance [1] (Junction/solder point)	Rth j-S	60	°C/W
Electrostatic Discharge Threshold (HBM)		8000	V

Notes:

- 1. Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad)
- 2. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 3. A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/ JESD625-A and JEDEC/J-STD-033)

Electrical / Optical Characteristics at TA=25°C

D	Symbol		TT **		
Parameter		Min.	Typ.	Max.	Unit
Wavelength at peak emission CIE127-2007* IF=150mA	λpeak		631*		nm
Dominant Wavelength CIE127-2007* IF=150mA	λdom [1]		623*		nm
Spectral bandwidth at 50% Φ Rel Max $$ If = 150mA	$\triangle \lambda$		25		nm
Forward Voltage IF=150mA	VF [2]	2	2.5	3.0	V
Allowable Reverse Current	IR			85	mA
Temperature coefficient of λpeak IF=150mA, -10°C≤ T≤100°C	TCλpeak		0.11		nm/°C
Temperature coefficient of λdom IF=150mA, -10°C≤ T≤100°C	TCλdom		0.09		nm/°C
Temperature coefficient of V_F IF=150mA, -10 $^{\circ}$ C \leq T \leq 100 $^{\circ}$ C	TCv		-2.6		mV/°C

Notes:

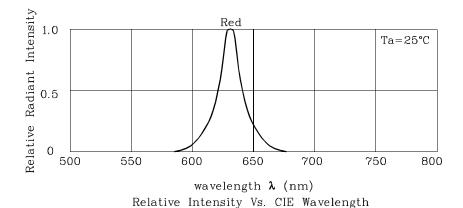
- 1. The dominant Wavelength (\$\lambda\$d) above is the setup value of the sorting machine. (Tolerance \$\lambda\$d: \$\pm\$1nm.)
- 2. Forward Voltage: +/-0.1V.
- $\mbox{*}$ Wavelength is in accordance with CIE127-2007 standards.

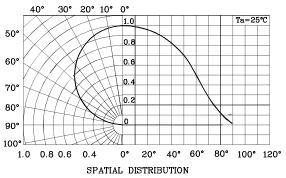
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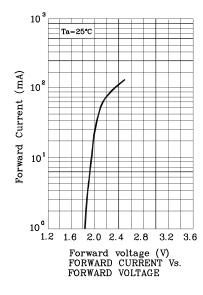
^{*} Luminous intensity / luminous flux value is in accordance with CIE127-2007 standards.

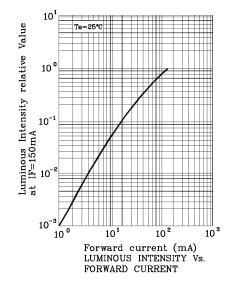


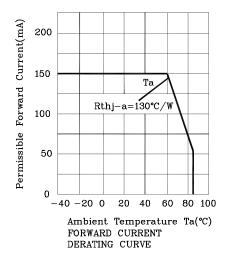


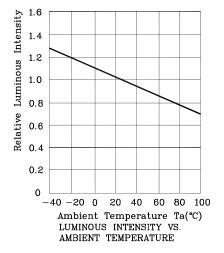






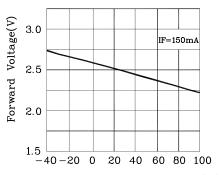




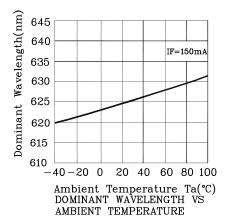


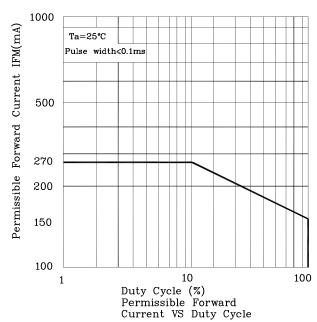






Ambient Temperature Ta(°C) FORWARD VOLTAGE VS. AMBIENT TEMPERATURE



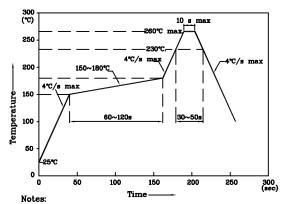




LED is recommended for reflow soldering and soldering profile is shown below.

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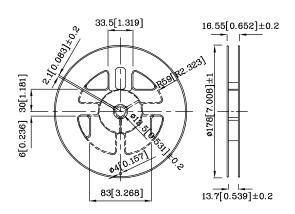
Reflow Soldering Profile for SMD Products (Pb-Free Components)



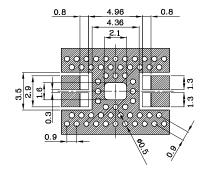
- Maximum soldering temperature should not exceed 260°C
 Recommended reflow temperature: 145°C-260°C
- Do not put stress to the epoxy resin during high temperatures conditions

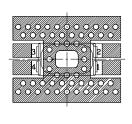
Recommended Soldering Pattern (Units: mm; Tolerance: ±0.1)

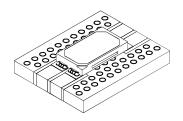
Reel Dimension



❖ The device has a single mounting surface. The device must be mounted according to the specifications.

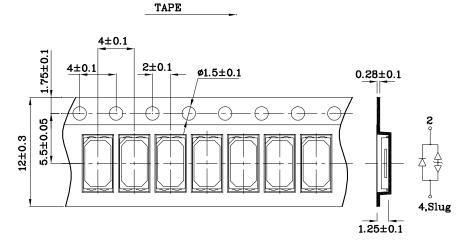






0.8mm FR4-Based Boards For both the open via PTH and filled and capped via design, the finished hole diameter is 0.5mm. A smaller diameter will lead to an increase of thermal resistance. The recommended distance between two holes is $0.4\ \mathrm{mm}$. This results in a minimal pitch of 0.9mm between the vias.

❖ Tape Specification (Units:mm)



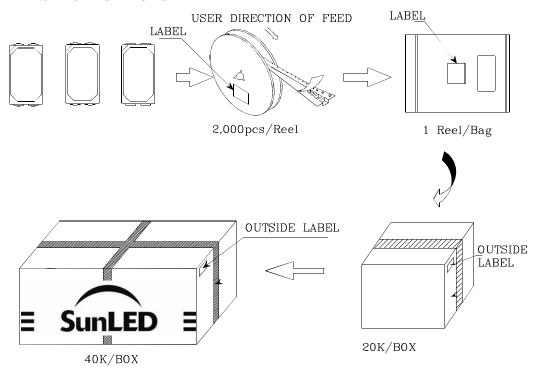
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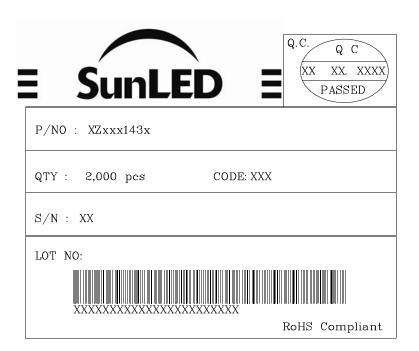
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PACKING & LABEL SPECIFICATIONS

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